

DEC. 7. 2004 1:02PM

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NO. 7723—P. 1

PTO/SB/97 (08-03)

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Signature

Raquel Garcia

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Application Number See attached Schedule A

Filing Date See attached Schedule A

In re of Applicant: Tokyo Ohka Kogyo Co., Ltd.

Art Unit unassigned

Examiner Name unassigned

Attorney Docket Number See attached Schedule A

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Change of Correspondence Address with attached Schedule A (3 pages)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re of Applicant: Tokyo Ohka Kogyo Co., Ltd. Docket No.: See attached Schedule A  
Serial No.: See attached Schedule A Art Unit: Not yet designated  
Filing Date: See attached Schedule A Examiner: Not yet designated

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313

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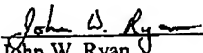
CHANGE OF CORRESPONDENCE ADDRESSES

Applicants respectfully requests the Examiner to change the correspondence address for the following applications as listed in the attached Schedule A to the address associated with the attorney of record:

Customer No.:	38,552		
Individual Name:	John W. Ryan		
Firm Name:	Dechert, LLP		
Address:	1775 I Street, NW		
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If necessary, please charge any fees in connection with this submission or credit any overpayments to our Deposit Account No. 50-2787. If you have any questions regarding this submission, please contact the undersigned attorney at the local Washington DC office.

Respectfully submitted,

  
John W. Ryan  
Registration No. 33,771

Date: December 7, 2004

DECHERT, LLP  
1775 I Street, N.W.  
Washington, DC 20006

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**Schedule A**  
**Change of Correspondence Address**  
**Client: Tokyo Ohka Kogyo Co., Ltd**  
**Customer Number: 38,552**

NO. 7723  
**Attorney Docket:** 372106-101  
**Title:** Resist Developer and Resist Pattern Formation Method Using Same  
**Client:** Tokyo Ohka Kogyo Co., Ltd.

Country	Application Number	Filing Date
US	10/622,548	24-Apr-2003

**Attorney Docket:** 372106-102

**Title:** SILICA-BASED ORGANIC FILM AND METHOD OF  
MANUFACTURING THE SAME, AND BASE MATERIAL  
COMPRISING ORGANIC FILM  
**Client:** Tokyo Ohka Kogyo Co., Ltd.

Country	Application Number	Filing Date
US	10/616,731	10-Jul-2003
US	10/800,822	15-Mar-2004

DECHERT LLP  
**Attorney Docket:** 372106-103  
**Title:** POSITIVE TYPE RESIST COMPOSITION AND RESIST  
PATTERN FORMATION METHOD  
**Client:** Tokyo Ohka Kogyo Co., Ltd.

Country	Application Number	Filing Date
US	10/666,172	14-Jul-2003

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**Schedule A**

**Change of Correspondence Address**  
**Client: Tokyo Ohka Kogyo Co., Ltd**  
**Customer Number: 38,552**

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**Attorney Docket: 372106-104**  
**Title: POSITIVE TYPE RESIST COMPOSITION AND RESIST**  
**PATTERN FORMATION METHOD**  
**Client: Tokyo Ohka Kogyo Co., Ltd.**

Country	Application Number	Filing Date
US	10/466,473	14-Jul-2003

**Attorney Docket: 372106-105**  
**Title: PHOTORESIST PATTERN AND FORMING METHOD THEREOF**  
**Client: Tokyo Ohka Kogyo Co., Ltd.**

Country	Application Number	Filing Date
US	10/628,919	29-Jul-2003

**Attorney Docket: 372106-106**  
**Title: Positive Type Resist Composition and Resist Pattern Formation**  
**Method Using Same**  
**Client: Tokyo Ohka Kogyo Co., Ltd.**

Country	Application Number	Filing Date
US	10/467,130	01-Aug-2003

**Attorney Docket: 372106-107**  
**Title: BASE MATERIAL FOR LITHOGRAPHY**  
**Client: Tokyo Ohka Kogyo Co., Ltd.**

Country	Application Number	Filing Date
US	10/648,762	26-Aug-2003

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**Schedule A**  
**Change of Correspondence Address**  
**Client: Tokyo Ohka Kogyo Co., Ltd**  
**Customer Number: 38,552**

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**Attorney Docket:** 372106-108

**Title:** Preparation for Nano Material Metal Oxide Nano Material Formation  
Composition Used for the Method, Mold and Metal Oxide Nano  
Structure

**Client:** Tokyo Ohka Kogyo Co., Ltd.

Country	Application Number	Filing Date
US	10/840,192	06-May-2004

**Attorney Docket:** 372106-109

**Title:** Resist Composition  
**Client:** Tokyo Ohka Kogyo Co., Ltd.

Country	Application Number	Filing Date
US	10/845,620	13-May-2004

**Attorney Docket:** 372106-110

**Title:** Positive Resist Composition and Formation Method of Resist Pattern  
**Client:** Tokyo Ohka Kogyo Co., Ltd.

Country	Application Number	Filing Date
US	10/859,904	03-Jun-2004

**Attorney Docket:** 372106-111

**Title:** Positive Resist Composition and Resist Pattern Forming Method  
**Client:** Tokyo Ohka Kogyo Co., Ltd.

Country	Application Number	Filing Date
US	10/865,940	10-Jun-2004

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